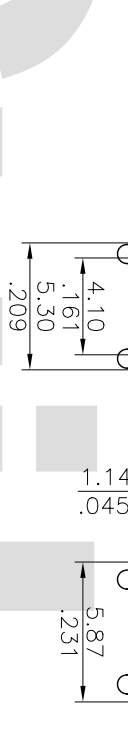
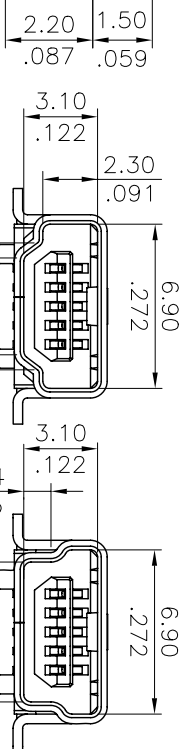
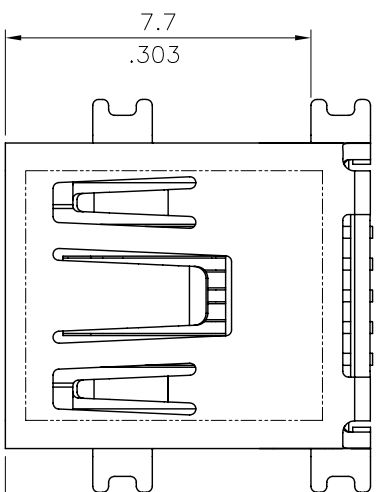


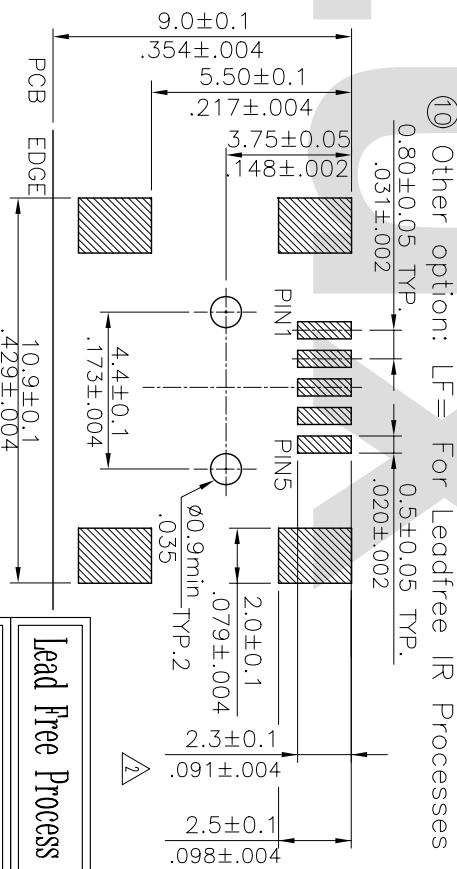
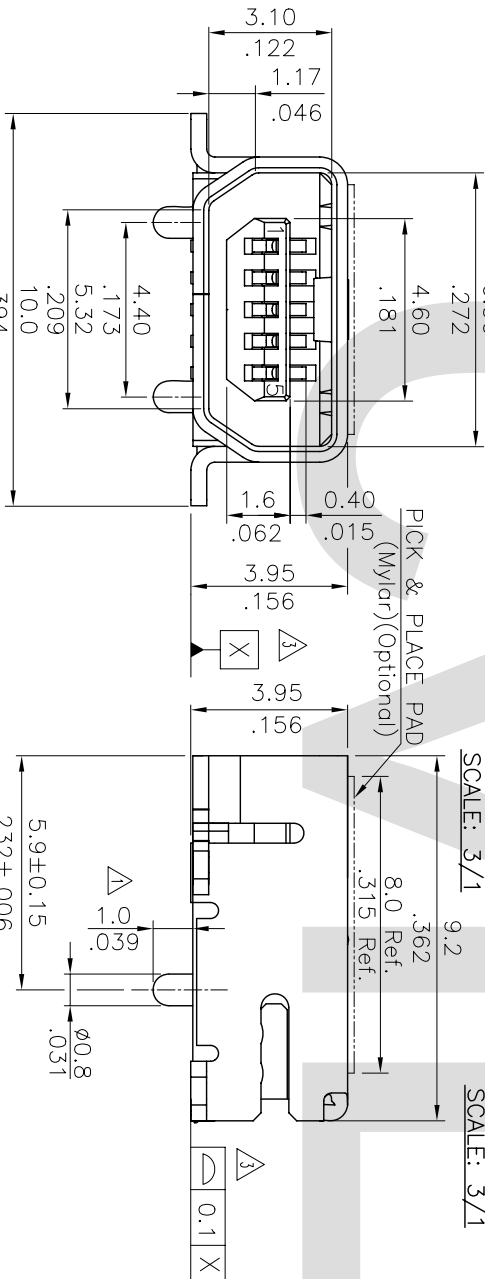
Materials :

- * Insulation: Glass filled Polyamide UL 94V-0
- * Contacts: Copper Alloy
- * Shell: Copper Alloy
- * Shell Plating:
120u" Tin plated over 30u" Nickel(Matte Tin Finish)
- * Pick & Place Pad : Glass filled polyamide
UL 94V-0
- * Solder tail with Matte Tin Finish



TYPE-A
P/N:CU04S*M05A0-*0-LF
SCALE: 3/1

TYPE-B
P/N:CU04S*M15B0-*0-LF
SCALE: 3/1



Ordering Code:

CU04 S * M * 5 * 0 -*0 -LF
① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩

- Series No.
- S = Socket
- Plating option:

A= Selective Gold flash plated
over 1.27um(50u") Nickel
C= Selective 0.76um(30u") Gold plated
over 1.27um(50u") Nickel

- Tail style: M = SMT Type
- Insulator Color: 0 = White 1 = Black 9 = Gray
- No of Circuits: 5 = 5 Pin
- Type: A = Mini USB 5 Pin Type-A (White)
B = Mini USB 5 Pin Type-B (Black)
C = Mini USB 5 Pin Type-AB (Gray)
- Option: 0 = Standard
- Packing Option:
-R0 = Tape & Reel Packing
(With Pick & Place Pad)
-T0 = Tube Packing
- Other option: LF = For Leadfree IR Processes
0.80±0.05 TYP.
0.51±.002
0.5±0.05 TYP.
0.20±.002

Recommended P.C. Board Layout

Lead Free Process
RoHS Compliant

△			DATE	UNIT: mm / inch	TITLE: MINI USB 5 PIN SMT BOARD MOUNT CONNECTOR	DRAWING NO.	PART NO.
△	Sansy	3/28-07	ECN07082/ECR07035-0	DRAWN BY: Sandy	4/11-07	CUSTOMER: BY1197	CU0416SD
△	Sansy	7/10/06	ECN06219	ENGINEER: Easley	4/17-07		CU04S*M*5*0-*0-LF
△	Sun	7/14/05	ECN05240	CHECKED BY: Easley	4/17-07		
△	NAME	DATE	REVISIONS	APPROVED BY: David	4/25-07	SCALE	SHEET 1 OF 1

瀚菱股份有限公司
Civilux Corporation